

## Electronic Patent Application Fee Transmittal

Application Number:	10511883
Filing Date:	19-Oct-2004
Title of Invention:	Apparatus and method for depositing thin film on wafer using remote plasma
First Named Inventor/Applicant Name:	Young Hoon Park
Filer:	James J. Merrick/Jessika Holmes
Attorney Docket Number:	YPL-0108

Filed as Large Entity

### U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>